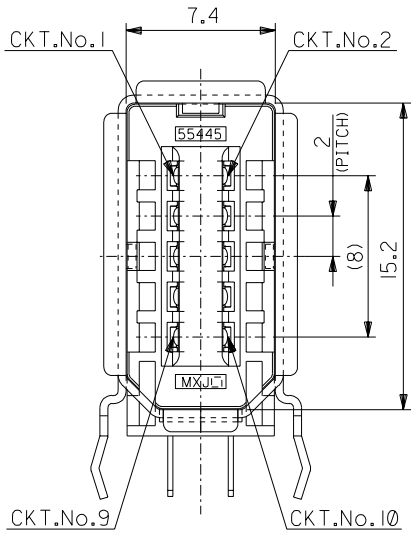
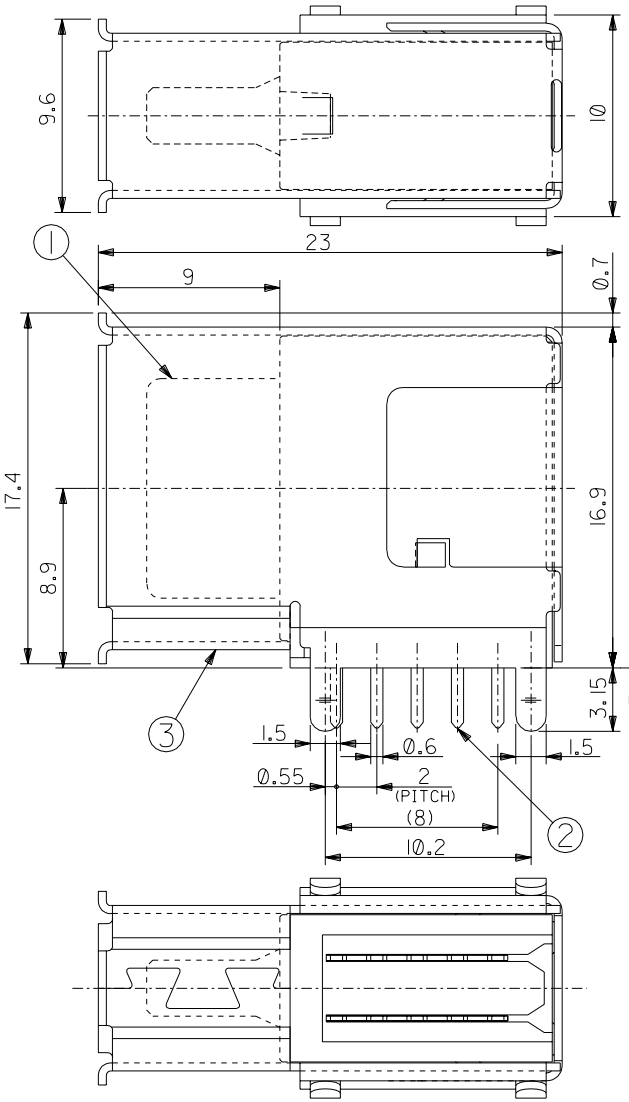
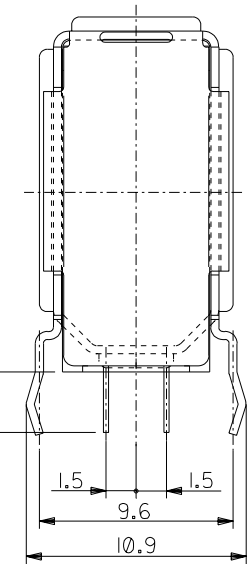
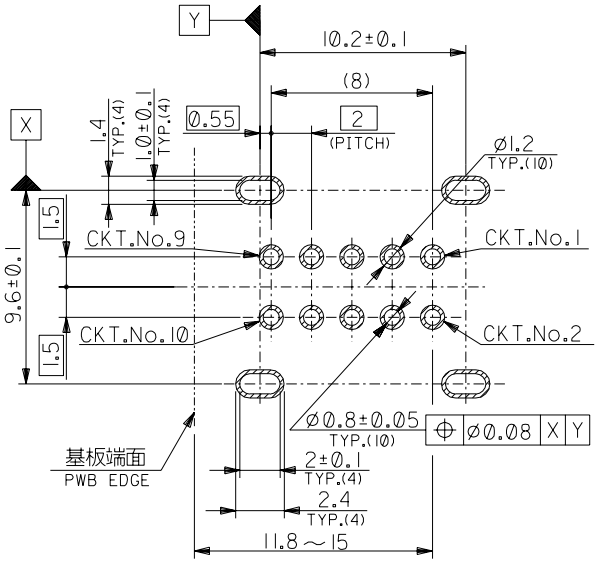
DWG. NO. SD-55445-004

部番 No.	部品名 PARTS NAME	材質 MATERIAL	記事 ARTICLE
①	ハウジング HOUSING	ガラス入り耐熱樹脂 G.F. HEAT RESISTANT PLASTIC	UL94V-0，色：黒 UL94V-0, COLOR : BLACK
②	ピン PIN	りん青銅 t0.25 PHOSPHOR BRONZE t0.25	接点部 ：金メッキ0.3μmMIN. CONTACT AREA : GOLD 0.3 μmMIN. 半田付け部：錫メッキ1.0μmMIN. SOLDERTAIL AREA : TIN 1.0 μmMIN. 下地メッキ：ニッケルメッキ2μmMIN. UNDER-PLATING : NICKEL 2 μmMIN.
③	シェル SHELL	鋼 t0.4 STEEL t0.4	錫メッキ：1.0μmMIN. TIN : 1.0 μmMIN. 下地メッキ：ニッケルメッキ1.27μmMIN. UNDER-PLATING : NICKEL 1.27 μmMIN.









推奨基板寸法（基板厚 t=1.6±0.2）
(COMPONEMT SIDE)
RECOMMENDED PCB PATTERN LAYOUT
(PCB THICKNESS t=1.6±0.2)

注記：
NOTES:

1. 本製品は 55445-1011 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 55445-1011.

55445-1019	55445-**19
MATERIAL.NO	MODEL.NO

DO NOT SCALE DRAWING

	EC NO.	DESCRIPTION	DRWN	CH'K	APPR
REV	0	RELEASED'04/04/14	M.NABEI	K.TOJO	M.SASAO
REV	J2004-3801				

MATERIAL 材料: 表参照 SEE TABLE
FINISH 仕上げ:
WIRE RANGE 適用電線範囲:
INS. RANGE 被覆外径:

GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差

10 UNDER 未満	±0.2
10 OVER 以上 30 UNDER 未満	±0.25
30 OVER 以上	±0.3
ANGLE 角度	±3°

SCALE 4-1 | DESIGN UNITS ☒mm ☐INCH | THIRD ANGLE PROJECTION
DIMENSIONS: ☐mm/INCH ☐INCH/mm ☒mm ONLY | SHT | REV | REVISE ON CAD ONLY
DRAWN BY & DATE '04/04/14 M.NABEI
CHECKED BY & DATE '04/04/14 K.TOJO
APPROVED BY & DATE '04/04/14 M.SASAO
CAD FILENAME SD-55445-004.S01
TITLE: 2.0 I/O SOCKET UPRIGHT DIP HS'G ASS'Y -LEAD FREE-
molex MOLEX INCORPORATED
MATERIAL NO. SEE CHART | DRAWING NO. SD-55445-004 | SHEET NO. 1 OF 1

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.

SIZE B

EN-02J(097) MXJ-54

SD-55445-004.S01